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M1MA141WAT1G, M1MA142WAT1G, SM1MA142WAT1G

Common Anode Silicon Dual Switching Diode

This Common Anode Silicon Epitaxial Planar Dual Diode is designed for use in ultra high speed switching applications. This device is housed in the SC-70 package which is designed for low power surface mount applications.

Features

- Fast t_{rr} , < 10 ns
- Low C_D, < 15 pF
- AEC-Q101 Qualified and PPAP Capable
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant*

MAXIMUM RATINGS ($T_A = 25^{\circ}C$)

Rating	Symbol	Value	Unit
Reverse Voltage M1MA141WAT1G M1MA142WAT1G, SM1MA142WAT1G	V _R	40 80	Vdc
Peak Reverse Voltage M1MA141WAT1G M1MA142WAT1G, SM1MA142WAT1G	V _{RM}	40 80	Vdc
Forward Current Single Dual	١ _F	100 150	mAdc
Peak Forward Current Single Dual	I _{FM}	225 340	mAdc
Peak Forward Surge Current M1MA141WAT1G M1MA142WAT1G, SM1MA142WAT1G	I _{FSM} (Note 1)	500 750	mAdc

THERMAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Power Dissipation	PD	150	mW
Junction Temperature	TJ	150	°C
Storage Temperature	T _{stg}	-55 ~ +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability. 1. t = 1 sec.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

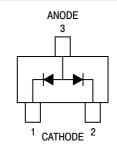


ON Semiconductor®

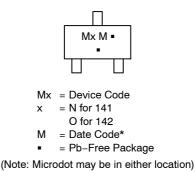
http://onsemi.com



SC-70 (SOT-323) CASE 419 STYLE 4



MARKING DIAGRAM



*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]			
M1MA141WAT1G	SC-70 (Pb-Free)	3,000 / Tape & Reel			
M1MA142WAT1G	SC-70 (Pb-Free)	3,000 / Tape & Reel			
SM1MA142WAT1G	SC-70 (Pb-Free)	3,000 / Tape & Reel			

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

M1MA141WAT1G, M1MA142WAT1G, SM1MA142WAT1G

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$)

Characteristic	Condition	Symbol	Min	Max	Unit
Reverse Voltage Leakage Current M1MA141WAT1G M1MA142WAT1G, SM1MA142WAT1G	V _R = 35 V V _R = 75 V	I _R		0.1 0.1	μAdc
Forward Voltage	I _F = 100 mA	V _F	-	1.2	Vdc
Reverse Breakdown Voltage M1MA141WAT1G, M1MA142WAT1G, SM1MA142WAT1G	I _R = 100 μA	V _R	40 80		Vdc
Diode Capacitance	V _R = 0, f = 1.0 MHz	CD	-	15	pF
Reverse Recovery Time (Figure 1)	$ I_F = 10 \text{ mA}, V_R = 6.0 \text{ V}, \\ R_L = 100 \ \Omega, I_{rr} = 0.1 I_R $	t _{rr} (Note 2)	-	10	ns

2. t_{rr} Test Circuit

M1MA141WAT1G, M1MA142WAT1G, SM1MA142WAT1G

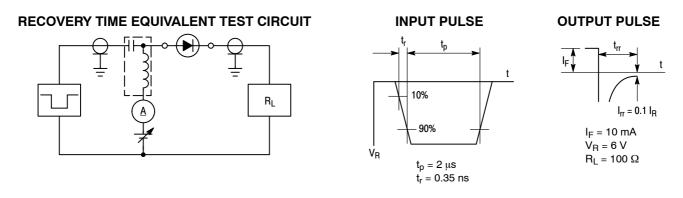
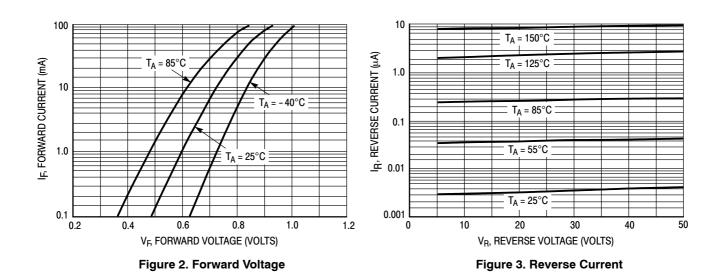
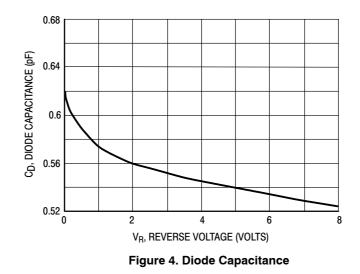


Figure 1. Recovery Time Equivalent Test Circuit

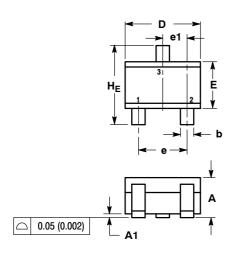




M1MA141WAT1G, M1MA142WAT1G, SM1MA142WAT1G

PACKAGE DIMENSIONS

SC-70 (SOT-323) CASE 419-04 ISSUE N



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

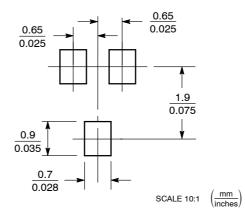
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.80	0.90	1.00	0.032	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A2	0.70 REF			0.028 REF		
b	0.30	0.35	0.40	0.012	0.014	0.016
С	0.10	0.18	0.25	0.004	0.007	0.010
D	1.80	2.10	2.20	0.071	0.083	0.087
Е	1.15	1.24	1.35	0.045	0.049	0.053
е	1.20	1.30	1.40	0.047	0.051	0.055
e1	0.65 BSC			0.026 BSC		
L	0.20	0.38	0.56	0.008	0.015	0.022
HE	2.00	2.10	2.40	0.079	0.083	0.095

STYLE 4: PIN 1 CATHODE

2. CATHODE

3. ANODE

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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